TPC R&D, Tasks towards the Design of the ILC TPC

LC TPC R&D Groups

OUTLINE of TALK

Overview of the question
Framework, R&D status

Gas-amplification systems
Prototypes
Facilities

Recent R&D results
I ssues, tasks

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HISTORY

1992: First discussions on detectors in Garmisch-Partenkirschen (LC92). Silicon? Gas?
1996-1997: TESLA Conceptual Design Report. Large wire TPC, 0.7Mchan.
1/2001: TESLA Technical Design Report. Micropattern (GEM, Micromegas) as a baseline, 1.5Mchan.
5/2001: Kick-off of Detector R&D
11/2001: DESY PRC proposal. for TPC R&D
(European & North American teams)
2002: UCLC/LCRD proposals
2004: After I TRP, WWS R&D panel

Europe

Chris Damerell (Rutherford Lab. UK) Jean-Claude Brient (Ecole Polytechnique, France) Wolfgang Lohmann (DESY-Zeuthen, Germany)

Asia

HongJoo Kim (Korean National U.) Tohru Takeshita (Shinsu U., Japan) Yasuhiro Sugimoto (KEK, Japan)

North America Dan Peterson (Cornell U., USA) Ray Frey (U. of Oregon, USA) Harry Weerts (Fermilab, USA)

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GOAL

To design and build an ultra-high performance

Time Projection Chamber

...as central tracker for the ILC detector, where excellent vertex, momentum and jet-energy precision are required

TPC R&D Groups

Europe RWTH Aachen DESY U Hamburg U Freiburg U Karlsruhe UMM Krakow Lund/Stockholm MPI - Munich NIKHEF BINP Novosibirsk LAL Orsay **IPN Orsay** U Rostock CEA Saclay PNPI StPetersburg America Carleton U Cornell/Purdue LBNL MI T U Montreal U Victoria Asian ILC gaseoustracking groups Chiba U Hiroshima U Minadamo SU-IIT Kinki U U Osaka Saga U Tokyo UAT U Tokyo NRICP Tokyo Kogakuin U Tokyo KEK Tsukuba U Tsukuba

Other USA MIT (LCRD) Temple/Wayne State (UCLC) Yale

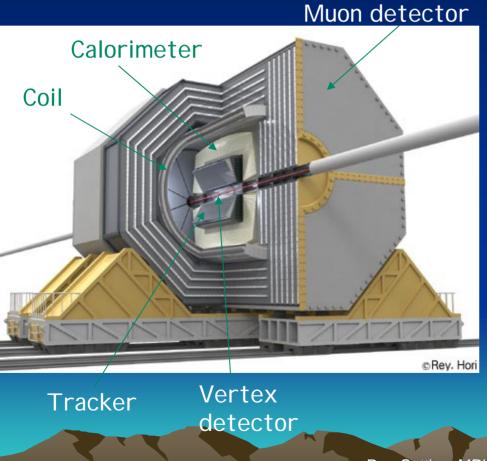
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"", OTHER?

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Detector for ILC experiments

Detector design Philosophy:



Good jet energy resolution

- → calorimeter inside a coil
- → highly segmented calorimeter
- Efficient & High purity b/c tagging
 - \rightarrow Thin VTX, put close to the IP
 - → Strong solenoid field
 - \rightarrow Pixel type

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- High momentum resolution
- Hermetic down to O(10)mrad

Shielded enough against
 beam-related background
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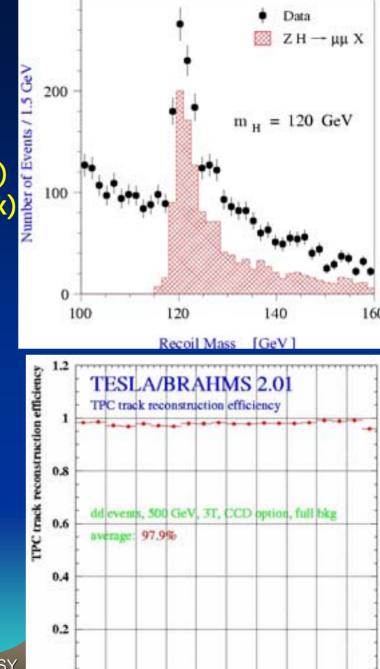
Physics determines detector design

momentum: d(1/p) ~ 10⁻⁴/GeV(TPC only) ~ 0.6x10⁻⁴/GeV(w/vertex) (1/10xLEP)

e⁺e⁻→ZH→II X goal: $\delta M_{\mu\mu}$ <0.1x Γ_Z → δM_H dominated by beamstrahlung

tracking efficiency: 98% (overall)

excellent and robust tracking efficiency by combining vertex detector and TPC, each with excellent tracking efficiency



0.1 0.2

0.3

0.4

0.5 0.6 0.7

0.8

0.9 (O)

27/01/2006

Motivation/Goals

 Continuous 3-D tracking, easy pattern recognition throughout large volume

- ~98% tracking efficiency in presence of backgrounds
- Timing to 2 ns together with inner silicon layer
- Minimum of X_0 inside Ecal (<3% barrel, <30% endcaps)
- $\sigma_pt \sim 100 \mu m$ (r ϕ) and $\sim 500 \mu m$ (rz) @ 3,4T for right gas if diffusion limited
- 2-track resolution <2mm (rφ) and <5-10mm (rz)
- dE/dx resolution <5% -> e/pi separation, for example
- Full precision/efficiency at 30 x estimated backgrounds

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R&D program

- gain experience with MPGD-TPCs, compare with wires
- study charge transfer properties, minimize ion feedback
- measure performance with different B fields and gases
- find ways to achieve the desired precision
- investigate Si-readout techniques
- start electronics design for 1-2 million pads
- study design of thin field cage
- study design thin endplate: mechanics, electronics, cooling
- devise methods for robust performance in high backgrounds
- pursue software and simulation developments

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Plans

• 1) Demonstration phase

 Continue work for ~1 year with small prototypes on mapping out parameter space, understanding resolution, etc, to prove feasibility of an MPGD TPC. For Si-based ideas this will include a basic proof-of-principle.

• 2) Consolidation phase

Build and operate "large" prototype (Ø ≥ 70cm, drift ≥ 50cm) within framework of EUDET grant from the EU which allows any MPGD technology, to test manufacturing techniques for MPGD endplates, fieldcage and electronics. Design work would start in ~1/2 year, building and testing another ~ 2 years.

• 3) Design phase

- After phase 2, the decision as to which endplate technology to use for the LC TPC would be taken and final design started.

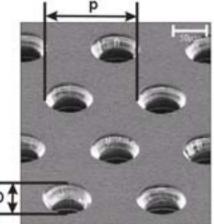
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TPC milestones

2005	Continue	testing,	design	large	prototype
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- 2006-2008 Test large prototype, decide technology
- 2009 Proposal of/final design of LC TPC
- 2013 Four years for construction
- 2014 Commission TPC alone
- 2015 Install/integrate in detector

GEM: Two copper foils separated by kapton, multiplication takes place in holes, uses 2 or 3 stages

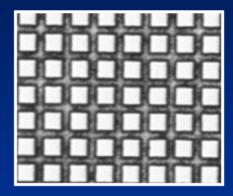


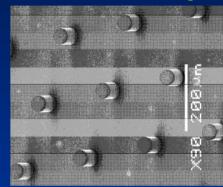
P~140 µm

D~60 µm

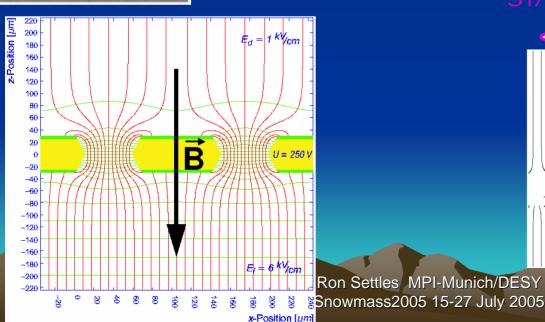
Gas-Amplification Systems: Wires & MPGDs→

Micromegas: micromesh sustained by 50µm pillars, multiplication between anode and mesh, one stage







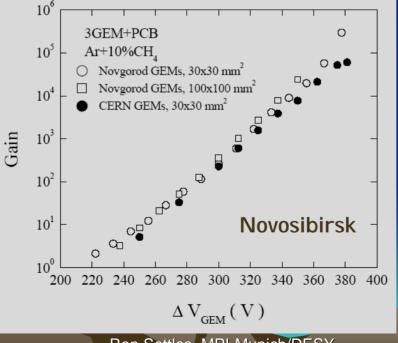


Gas-Amplification Systems: Possible manufacturers

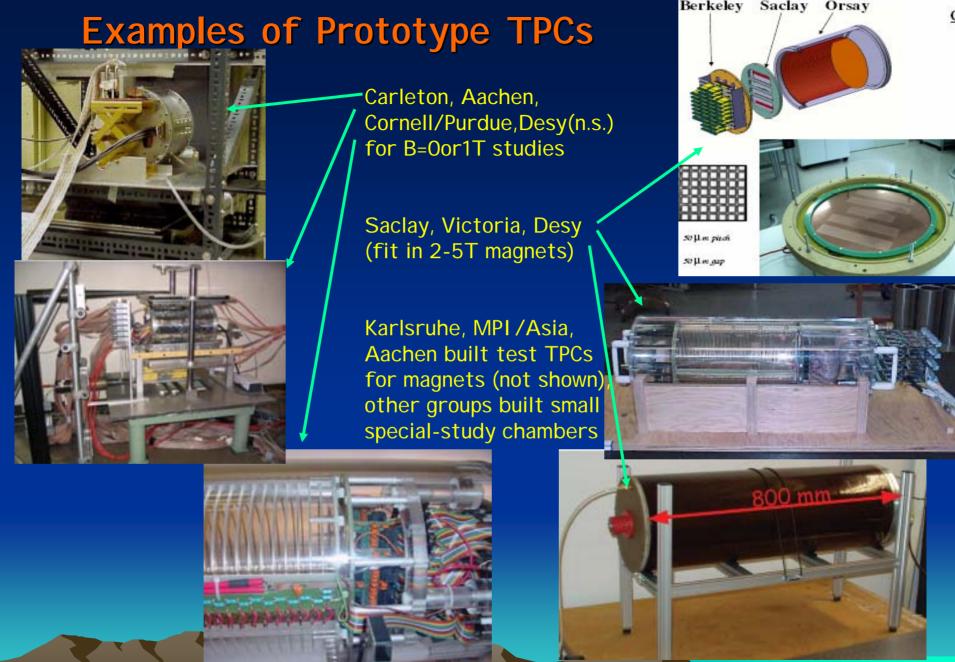
GEM: --CERN

- --Novogorod (Russia)
- --Purdue + 3M (USA)
- --other companies interested in Europe, Japan and USA

Micromegas: --CERN together with Saclay/Orsay on techniques for common manuf. of anode + pillars --Purdue/3M



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1-6 GeV Electron Beam **Optional Target** Three Layer Beam Telescope TPC (Position 2) 0.5 T Magnet TPC (Position 1)

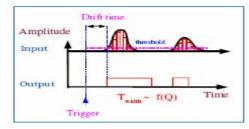
Recent TPC R&D results summer 2005

by the LC TPC R&D Groups

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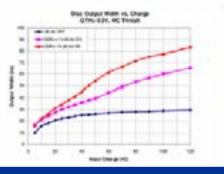
Charge measurement with <u>Time-to-Digit</u> Converter



Main idea: use charge-to-time conversion technique

Readout electronics

ASDQ: Amplifier-Shaper-Discriminator-Q(charge measurement). developed for CDF's Central Outer Tracker

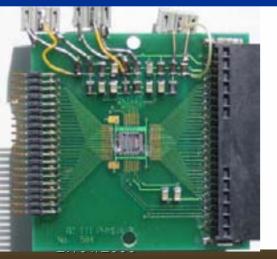


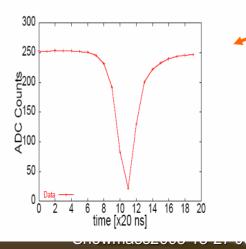


Work on Electronics

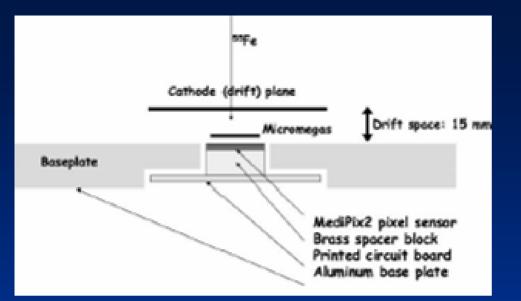
Aleph and Star setups (3 of each) used for prototype work don't take advantage of fast Gem/Mm signals from direct e-.

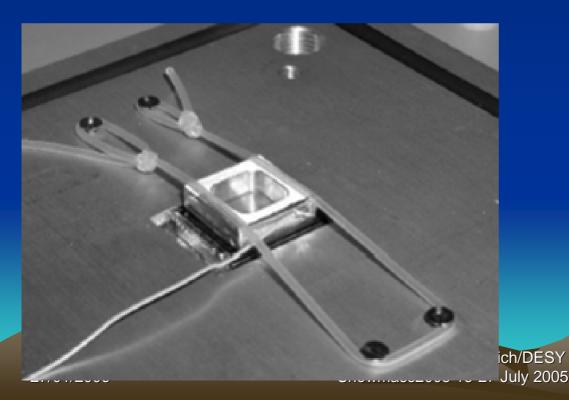
- Rostock working on TDC idea.
- Aachen/Desy/Lund studying highly integrated conventional approach.
 - Nikhef developing "Si RO" concepts (next slide)





DESY





Electronics Development

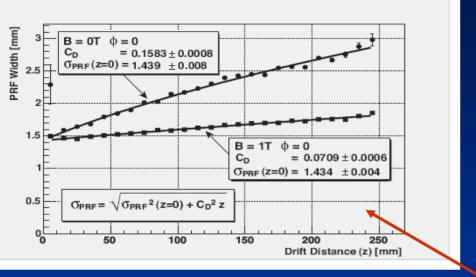
Nikhef on CMOS readout techniques, joined by Saclay

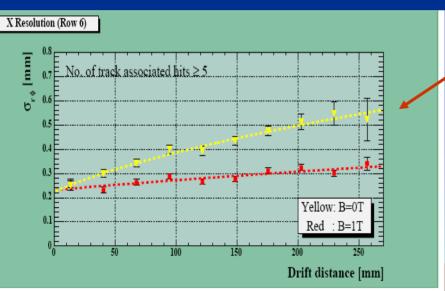
~ 50 x 50 µm^2 CMOS pixel

matrix + Micromegas or Gem

- preamp, discr, thr.daq, 14-bit
 ctr, time-stamp logic / pixel
- huge granularity(digital TPC), diffusion limited, sensitive to indiv. clusters for right gas
- ~ 1st tests with Micromegas
 - + MediPix2 chip

→ more later...





Prototype Results Point resolution, Wires

--Measured by Asia/MPI/Desy teams in MPI wire chamber and KEK magnet at KEK test beam (1-4 GeV hadrons with PID), B=0&1T, TDR gas

--2x6mm² pads, 1mm wire-to-pad gap

--PRF width measured to be = 1.43mm

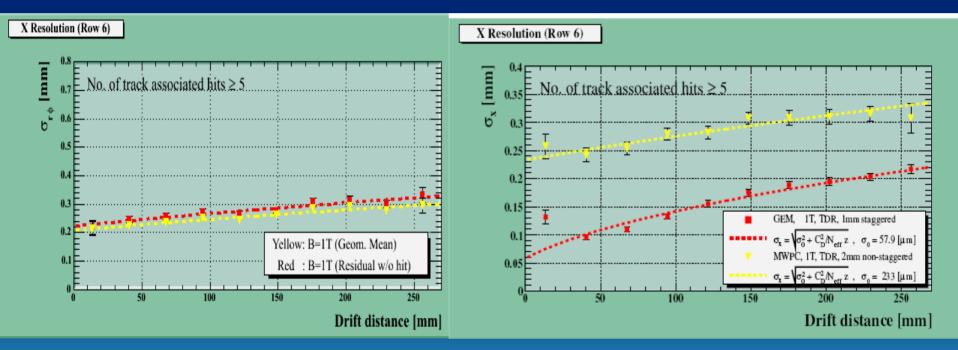
--Point resolution measured by fitting track to outer 6 rows and comparing track to hit on innermost 7th row. This method is known to overestimate the resolution (better method being implemented—see next slides)

KEK/MPI beam test: resolution as function of drift distance at B = 1T.

Method: fit track with and without row in question (row#6). Geometric mean of the two results gives the correct resolution.

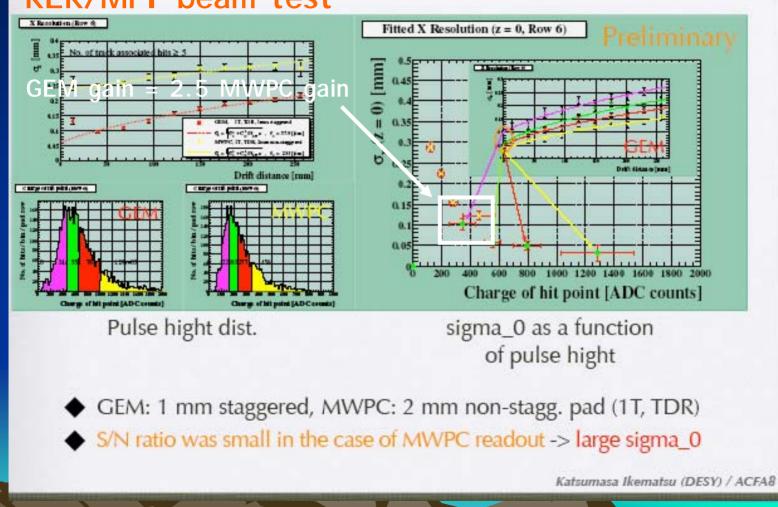
Wires, expect~170µm resolution:

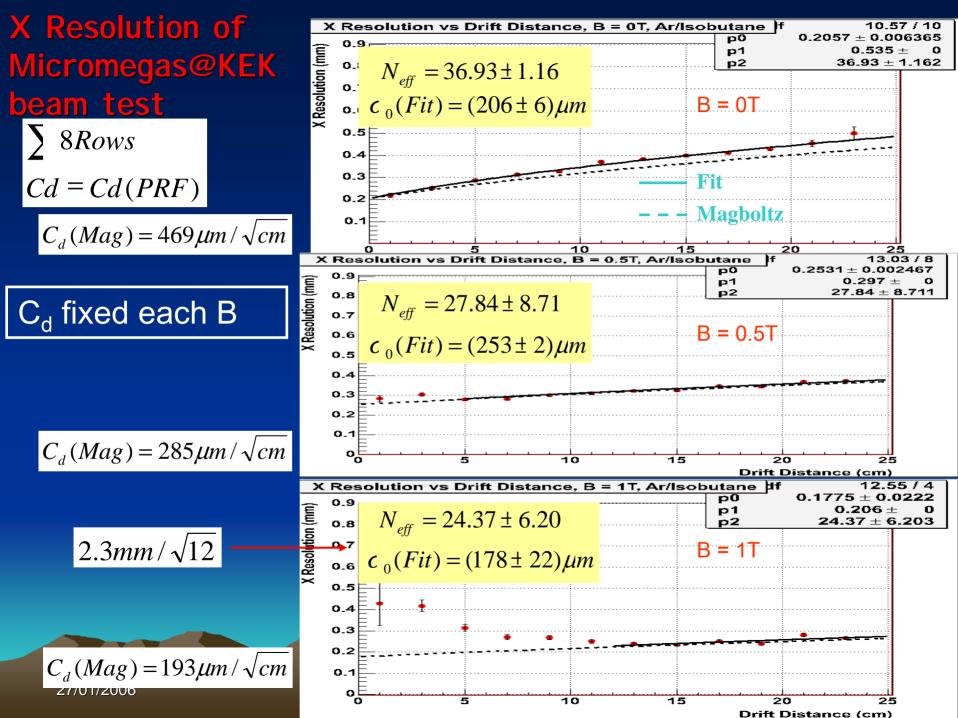
GEM beamtest, compare to wires:



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Comparison between GEM & MWPC KEK/MPI beam test



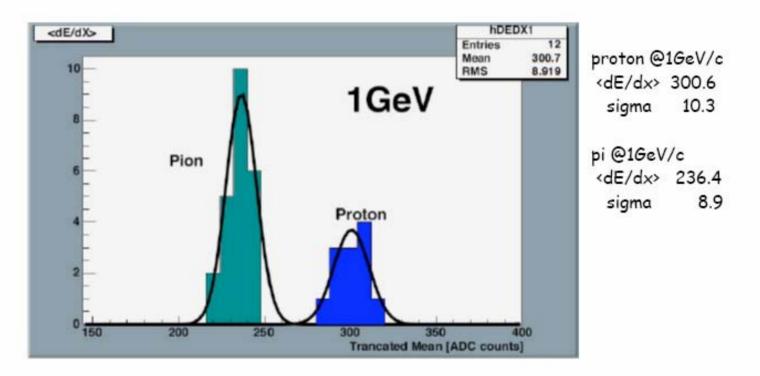


Prototype Results dE/dx, wires, KEK beam test

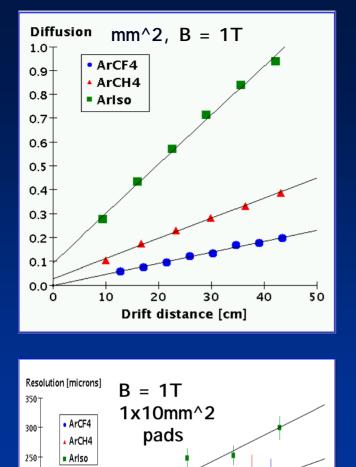
dE/dx in TDR gas

7 pad-raw /event × 30 events -> 210 sampling

OdE/dx ~ 3.4% (→ 7.9% w/40 samples) not a correct truncated mean. good w/o calib., any corrections



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Prototype Results Point resolution, Micromegas

> Saclay/Orsay/Berkeley --Ageing negligible --Diffusion measurements \Rightarrow $\sigma_pt < 100\mu m$ possible

 --At moment only achieved for short drift (intrinsic σ) for gain~5000 (350V mesh), noise~1000e

--Analysis continuing...

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50

45

200-

150-

100

50

10

5

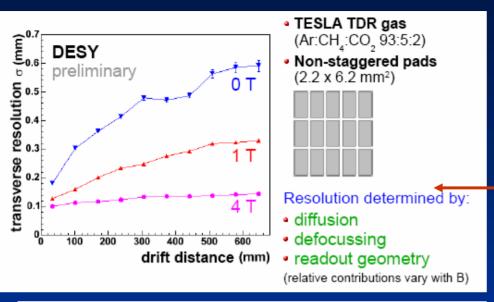
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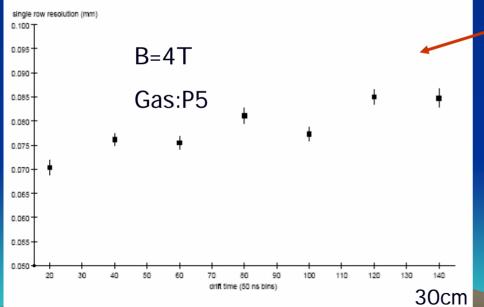
30

25

Drift distance [cm]

35





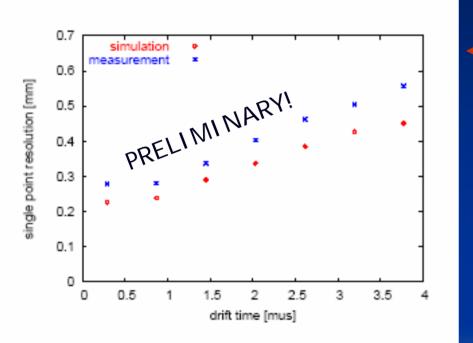
Prototype Results Point resolution, Gem

--Three examples of σ_pt measured for Gems and 2x6mm² pads.

--First, in Desy chamber (triple Gem), resolution using "triplet method".

--Second, in Victoria chamber (double Gem), unbiased method used: track fit twice, with and without padrow in question, σ determined for each case; geometric mean of the two σ 's gives the correct result.

--See next page...



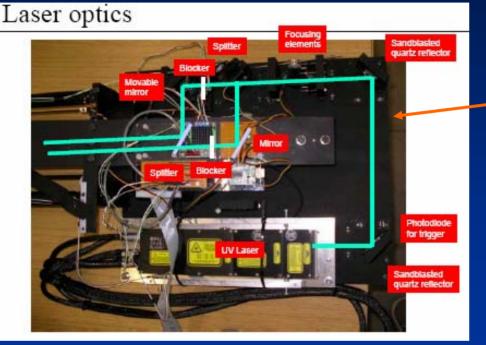
Prototype Results Point resolution, Gem

--Third example of σ_{pt} measured at Aachen Gems and 2x6mm² pads by comparing track position with a Si hodoscope.

--In general (also for Micromegas) the resolution is not as good as simulations expect; we are searching for why (electronics, noise, method).

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Prototype Results Two-track resolution studies



 σ_{point} for cosmics ~ laser ~ 80 μ m

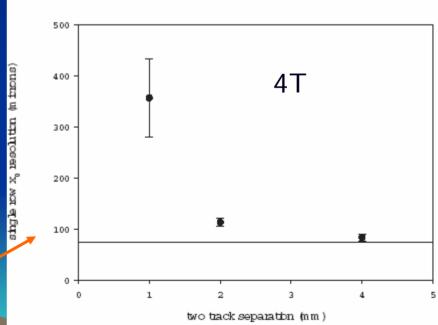
2-track resol. for lasers ~ 1-2mm: how the resolution on one track is affected by presence of a nearby parallel track at same drift dist

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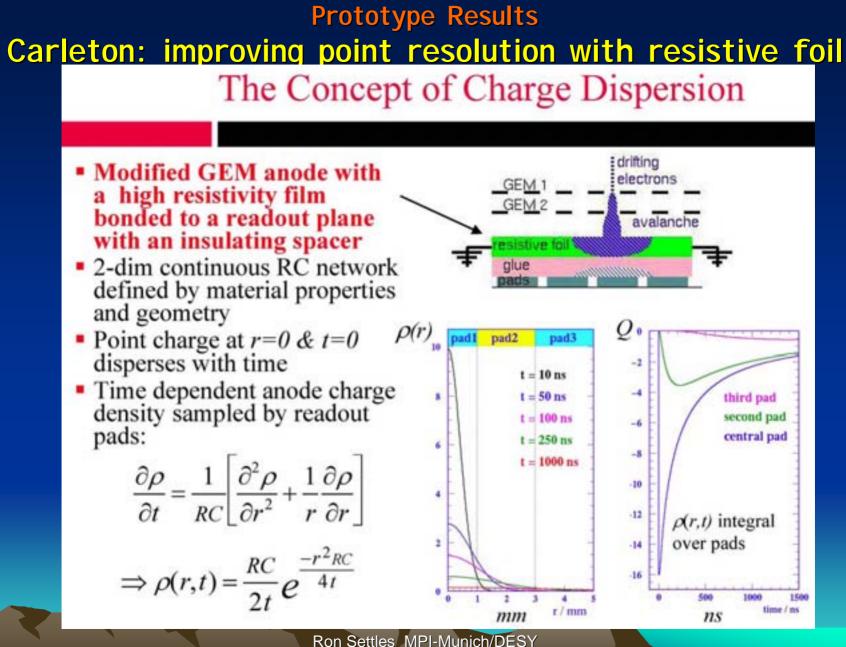
Studies just starting.

 Victoria steering mechanics, Desy laser and 5T magnet.

Two track resolution at 4T



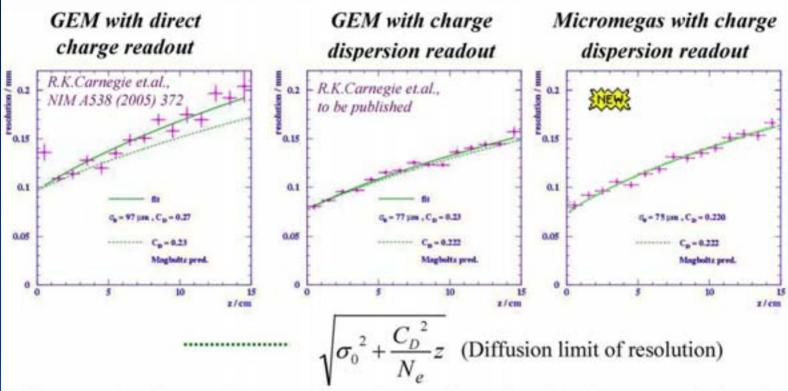
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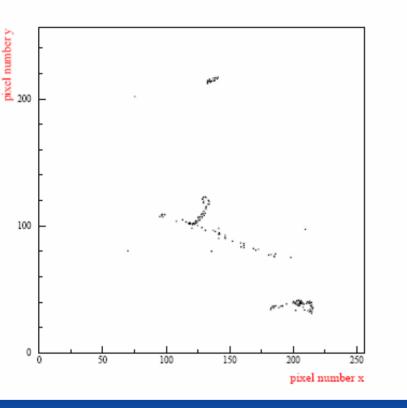
Carleton: resistive foil results

TPC transverse resolution for Ar:CO₂ (90:10)



Compared to direct charge readout, charge dispersion gives better resolution for GEM with Z dependence close to the diffusion limit. For Micromegas, the resolution is also better than for direct charge GEM readout.

Medipix2+Micromegas: results@Nikhef



--Single-electron sensitivity demonstrated: Fe55 source, open30s/close, He/20%I sobut., threshold=3000e, gain=19K (-470V Mmegas), -1kV drift

--Measure diffusion const.~ 220 μ m/ \star m, N_cluster~0.52/mm, in reasonable agreement with simulation

--NIM A540 (2005) 295 (physics/0409048)

--Future: develop *"TimePixGrid"* prototype by Nikhef/Saclay/et.al. for TPC application: see next slide...

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InGrid

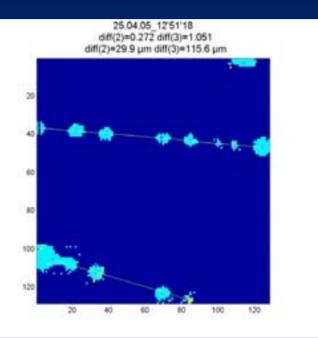
Integrate GEM/Micromegas and pixel sensor



<u>v 'wafer post processing'</u>

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Medipix2+GEMS: results@Freiburg



--GEM+Medipix2 sensitivity demonstrated: Cosmic by external telescope
--Measure diffusion const.~ ?µm/ √cm

--Future: studies continuing

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TPC R&D Summary

- Experience with MPGDs being gathered rapidly
- Gas properties rather well understood
- Diffusion-limited resolution seems feasible
- Resistive foil charge-spreading demonstrated
- CMOS RO demonstrated
- Design work starting

TPC central-tracker tasks -> Snowmass concept and/or tracking sessions

ISSUES

- Performance/Simulation
- Design
- Backgrounds, alignment, corrections

Performance/Simulation -> Snowmass concept session

- Momentum precision needed for overall tracking?
- Momentum precision needed for the TPC?
- Arguments for dE/dx, V° detection
- Requirements for
 - 2-track resolution (in rφ and z)?
 - track-gamma separation (in rφ and z)?
- Tolerance on the maximum endplate thickness?
- Tracking configuration
 - Calorimeter diameter
 - TPC
 - Other tracking detectors
- TPC outer diameter
- TPC inner diameter
- TPC length

field?

Required B-mapping accuracy in case of non-uniform B-

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-> Snowmass concept/tracking sessions

- Gas-Amplification technology → input from R&D projects at Snowmass tracking session
 - Chamber gas candidates

- Electronics design: maximum density possible?

- Zeroth-order "conventional-RO" design
- Is there an optimum pad size for momentum, dE/dx resolution and electronics packaging?
- Silicon RO: proof-of-principle
- Endplate design
 - Mechanics
 - Minimize thickness
 - Cooling
- Field cage design

Backgrounds/alignment/distortion-correction

-> Snowmass concept/tracking sessions

- Revisit expected backgrounds
 -> joint with MDI
- Maximum positive-ion buildup tolerable?
- Maximum occupancy tolerable?
- Effect of positive-ion backdrift: gating plane?
- Tools for correcting space charge in presence of bad backgrounds?